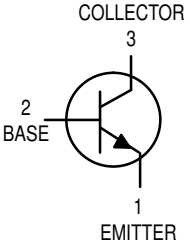
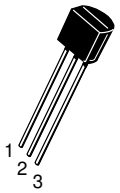
High Voltage Transistors
NPN Silicon

MPSA42*
MPSA43

*Motorola Preferred Device





CASE 29–04, STYLE 1
TO–92 (TO–226AA)

MAXIMUM RATINGS

Rating	Symbol	MPSA42	MPSA43	Unit
Collector–Emitter Voltage	V_{CEO}	300	200	Vdc
Collector–Base Voltage	V_{CBO}	300	200	Vdc
Emitter–Base Voltage	V_{EBO}	6.0	6.0	Vdc
Collector Current — Continuous	I_C	500		mAdc
Total Device Dissipation @ T_A = 25°C Derate above 25°C	P_D	625 5.0		mW mW/°C
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	1.5 12		Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	−55 to +150		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/mW
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/mW

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage[1] (I_C = 1.0 mAdc, I_B = 0)	 MPSA42 MPSA43	$V_{(BR)CEO}$	 300 200	 — —	Vdc
Collector–Base Breakdown Voltage (I_C = 100 μAdc, I_E = 0)	 MPSA42 MPSA43	$V_{(BR)CBO}$	 300 200	 — —	Vdc
Emitter–Base Breakdown Voltage (I_E = 100 μAdc, I_C = 0)		$V_{(BR)EBO}$	6.0	—	Vdc
Collector Cutoff Current (V_{CB} = 200 Vdc, I_E = 0) (V_{CB} = 160 Vdc, I_E = 0)	 MPSA42 MPSA43	I_{CBO}	 — —	 0.1 0.1	μAdc
Emitter Cutoff Current (V_{EB} = 6.0 Vdc, I_C = 0) (V_{EB} = 4.0 Vdc, I_C = 0)	 MPSA42 MPSA43	I_{EBO}	 — —	 0.1 0.1	μAdc

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Max	Unit
ON CHARACTERISTICS(1)					
DC Current Gain		h_{FE}			—
(I_C = 1.0 mAdc, V_{CE} = 10 Vdc)			25	—	
(I_C = 10 mAdc, V_{CE} = 10 Vdc)			40	—	
(I_C = 30 mAdc, V_{CE} = 10 Vdc)			40	—	
Collector–Emitter Saturation Voltage		$V_{CE(sat)}$			Vdc
(I_C = 20 mAdc, I_B = 2.0 mAdc)	MPSA42		—	0.5	
	MPSA43		—	0.4	
Base–Emitter Saturation Voltage		$V_{BE(sat)}$	—	0.9	Vdc
(I_C = 20 mAdc, I_B = 2.0 mAdc)					
SMALL–SIGNAL CHARACTERISTICS					
Current–Gain — Bandwidth Product		f_T	50	—	MHz
(I_C = 10 mAdc, V_{CE} = 20 Vdc, f = 100 MHz)					
Collector–Base Capacitance		C_{cb}			pF
(V_{CB} = 20 Vdc, I_E = 0, f = 1.0 MHz)	MPSA42		—	3.0	
	MPSA43		—	4.0	

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

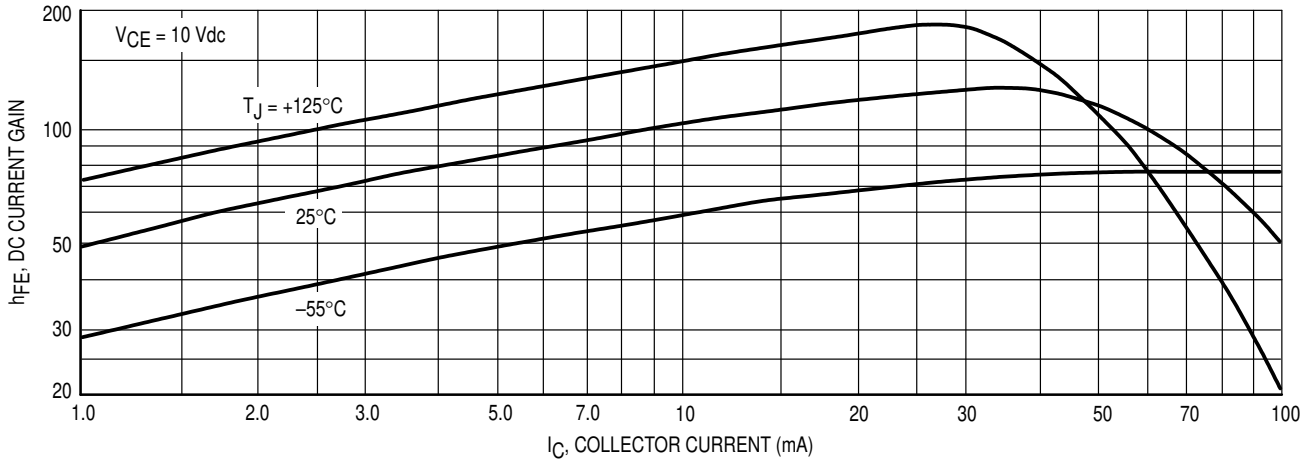


Figure 1. DC Current Gain

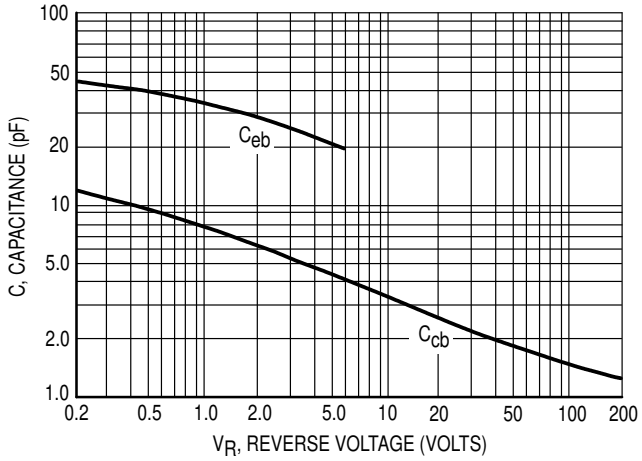


Figure 2. Capacitances

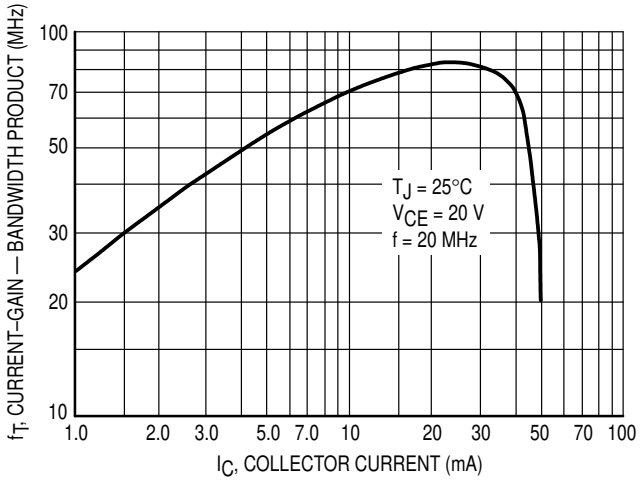


Figure 3. Current–Gain — Bandwidth Product

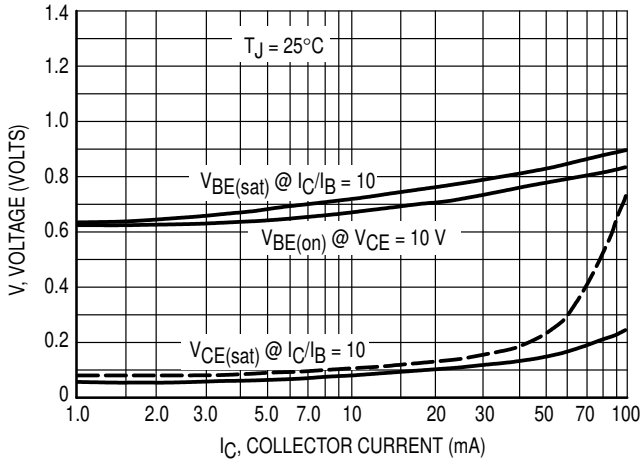


Figure 4. "On" Voltages

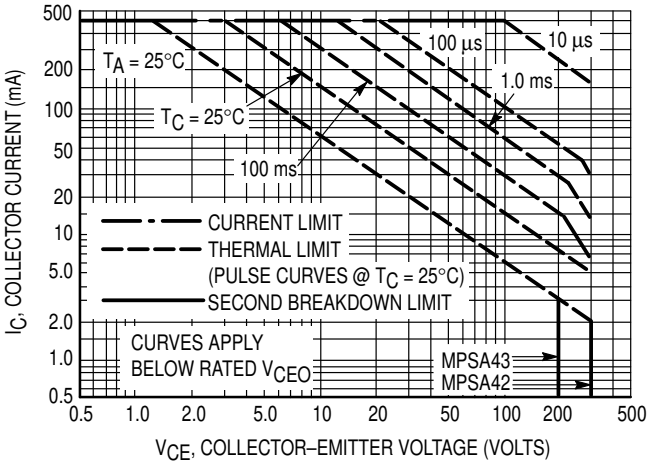
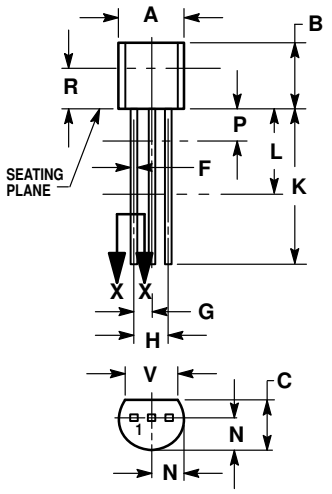
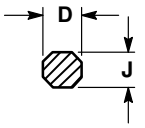


Figure 5. Maximum Forward Bias Safe Operating Area

PACKAGE DIMENSIONS





SECTION X–X

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.022	0.41	0.55
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	—	12.70	—
L	0.250	—	6.35	—
N	0.080	0.105	2.04	2.66
P	—	0.100	—	2.54
R	0.115	—	2.93	—
V	0.135	—	3.43	—

CASE 029–04
(TO–226AA)
ISSUE AD

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

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